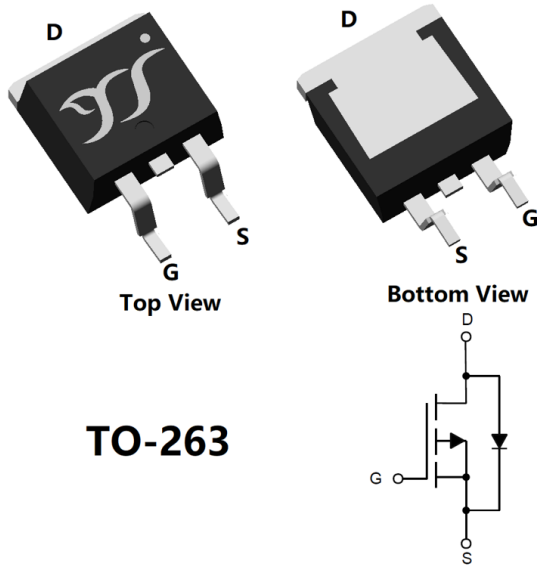


P-Channel Enhancement Mode Field Effect Transistor



TO-263

Product Summary

V_{DS}	-60 V
I_D	-100 A
$R_{DS(ON)}$ (at $V_{GS}=-10V$)	<8.8m
$R_{DS(ON)}$ (at $V_{GS}=-6V$)	<10m
100% EAS Tested	
100% ∇V_{DS} Tested	

General Description

$V_{DS} = -10V$, $I_D = 32A$ RPU YT
 High density cell design for low $R_{DS(ON)}$
 2 Pellet stability and uniformity
 : Va R R W 9R RY
 2 : R Ra B9 & C-0 Flammability Rating
 5NYTR 3 RR

Applications

= R ZN NTRZR a
 = aNORR VZR a

Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		V_{DS}	-60	V
Gate-source Voltage		V_{GS}	± 18	V
Drain Current	$T_A=25^\circ C$	I_D	-14	A
	$T_A=100^\circ C$		-9	
	$T_C=25^\circ C$		-100	
	$T_C=100^\circ C$		-63	
Pulsed Drain Current ^A		I_{DM}	-320	A
Avalanche energy ^B		EAS	625	mJ
Total Power Dissipation ^C	$T_A=25^\circ C$	P_D	2.7	W
	$T_A=100^\circ C$		1.1	
	$T_C=25^\circ C$		178	
	$T_C=100^\circ C$		71	
Junction and Storage Temperature Range		T_J, T_{STG}	-55~+150	$^\circ C$

Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient ^D	Steady-State	$R_{\theta J}$	35	45	$^\circ C/W$
Thermal Resistance Junction-to-Case	Steady-State	$R_{\theta JC}$	0.6	0.7	

Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJB100GP06H	F2	YJB100GP06H	800	/	8000	13 reel



YJB100GP06H

Electrical Characteristics (T_J=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =-	-60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V, V _{GS} =0V	-	-	-1	-
		V _{DS} =-60V, V _{GS} =0V, T _J =150°C	-	-	-100	
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±18V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =-	-2.0	-2.6	-4.0	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-50A	-	6.5	8.8	Z
		V _{GS} =-10V, I _D =-20A	-	6.5	8.8	
		V _{GS} =-6V, I _D =-20A	-	7.2	10	
Diode Forward Voltage	V _{SD}	I _S =-50A, V _{GS} =0V	-	-0.95	-1.2	V
Gate resistance	R _G	f=1MHz, Open drain	-	9	-	
Maximum Body-Diode Continuous Current	I _S		-	-	-100	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =-30V, V _{GS} =0V, f=1MHz	-	5370	-	pF
Output Capacitance	C _{oss}		-	970	-	
Reverse Transfer Capacitance	C _{riss}		-	72	-	
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =-10V, V _{DS} =-30V, I _D =-20A	-	82	-	nC
Gate-Source Charge	Q _{gs}		-	25	-	
Gate-Drain Charge	Q _{gd}		-	17	-	
Reverse Recovery Charge	Q _{rr}	I _F =-20A, di/dt=500A/us	-	45	-	nC
Reverse Recovery Time	t _{rr}		-	150	-	ns
Turn-on Delay Time	t _{D(on)}	V _{GS} =-10V, V _{DD} =-30V, I _D =-20A R _{GEN} =1.6	-	15	-	ns
Turn-on Rise Time	t _r		-	50	-	
Turn-off Delay Time	t _{D(off)}		-	135	-	
Turn-off fall Time	t _f		-	160	-	

A. Repetitive rating; pulse width limited by max. junction temperature.

B. T_J=25°C, V_{DD}=-50V, V_G=-10V, 4 9 2mH, I_{AS}=-25A.

C. P_a is based on max. junction temperature, using junction-case and junction-ambient thermal resistance.

D. The value of R_γ is measured with the device mounted on 1 in² FR-4 board with 2oz. Copper, in the still air environment with T_A=25°C.

The maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.



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Typical Electrical and Thermal Characteristics Diagrams

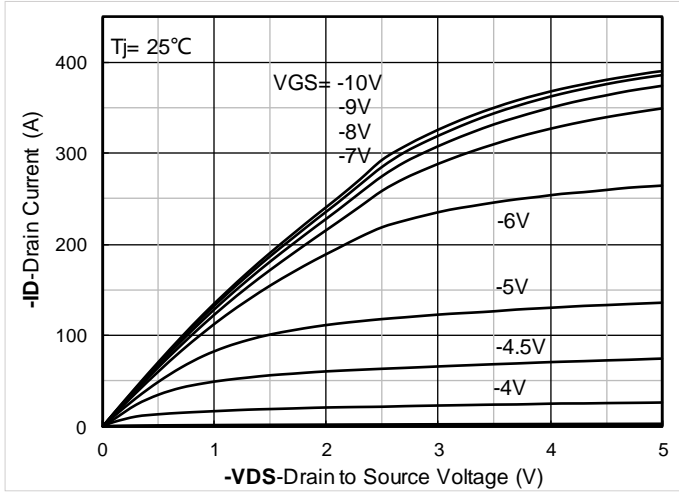


Figure 1. Output Characteristics

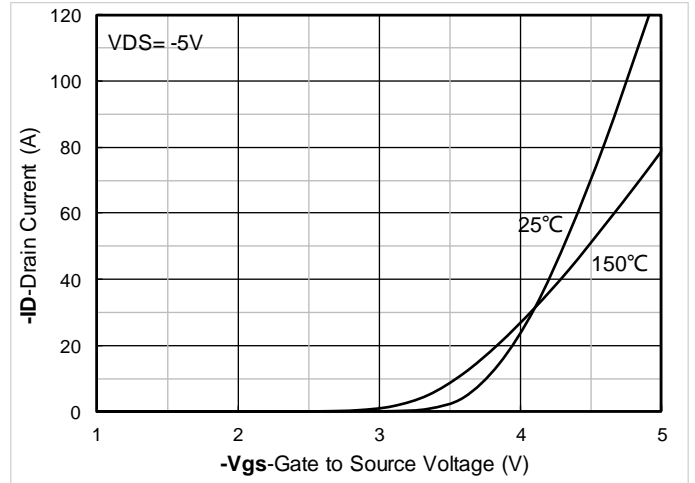


Figure 2. Transfer Characteristics

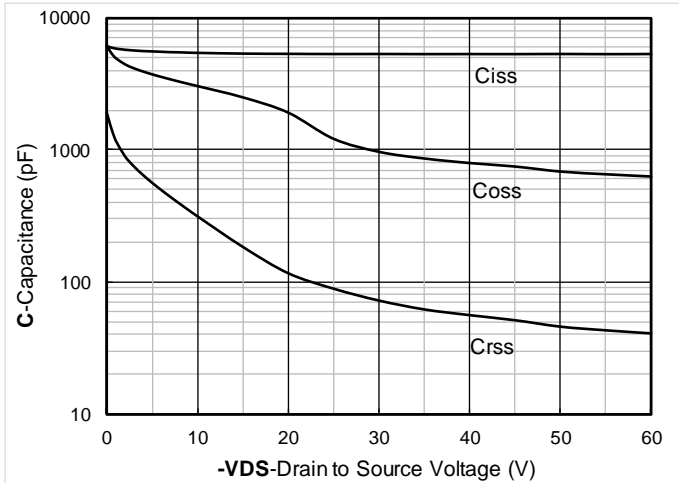


Figure 3. Capacitance Characteristics

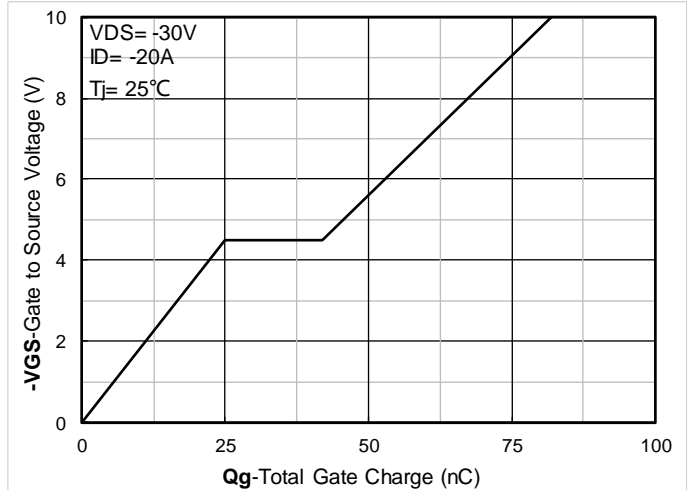


Figure 4. Gate Charge

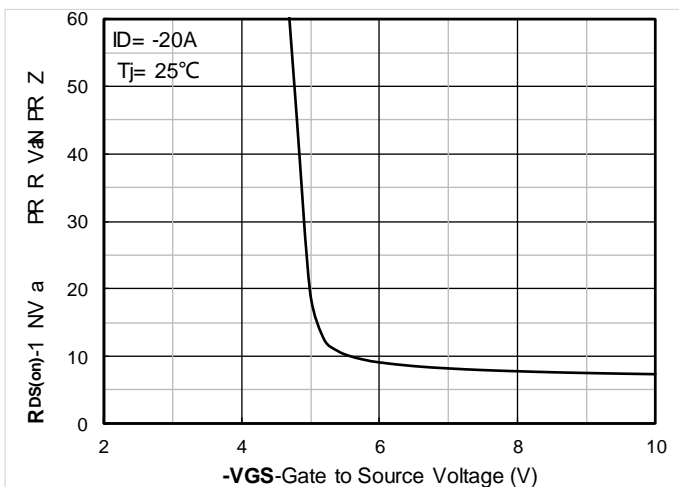


Figure 5. On-Resistance vs Gate to Source Voltage

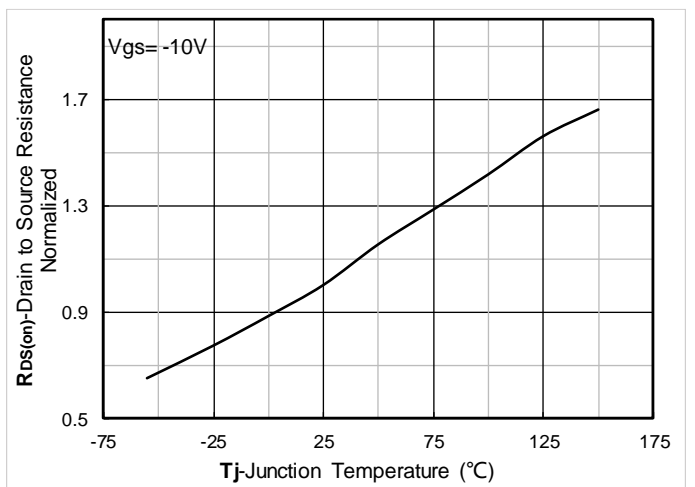


Figure 6. Normalized On-Resistance



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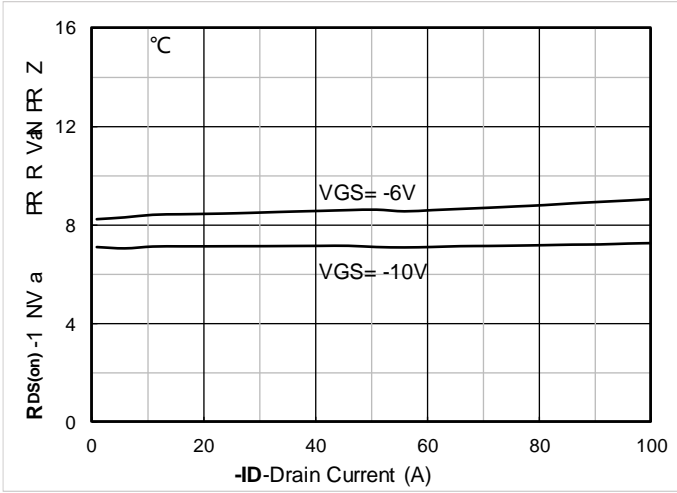


Figure 7. RDS(on) VS Drain Current

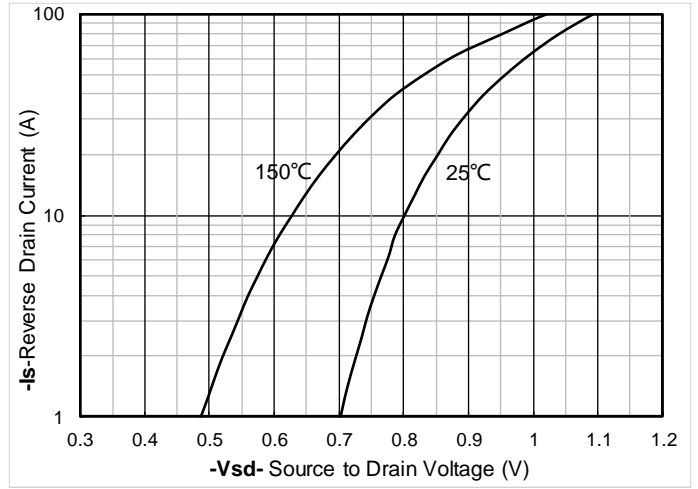


Figure 8. Forward characteristics of reverse diode

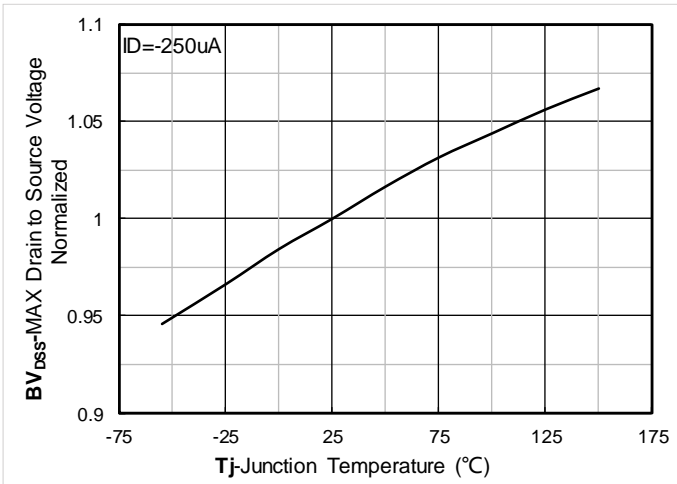


Figure 9. Normalized breakdown voltage

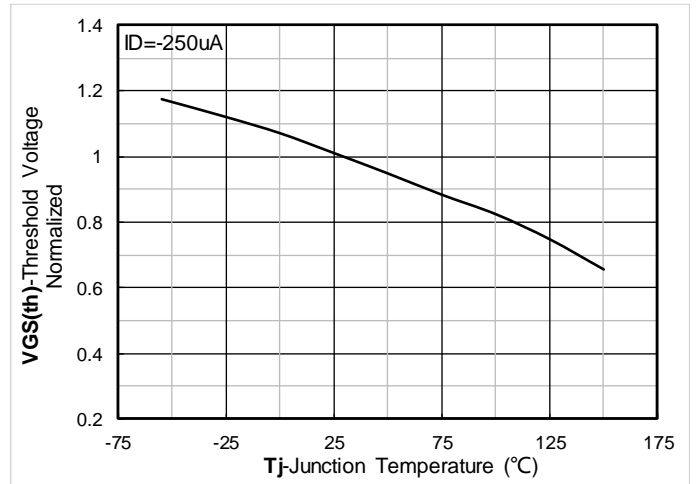


Figure 10. Normalized Threshold voltage

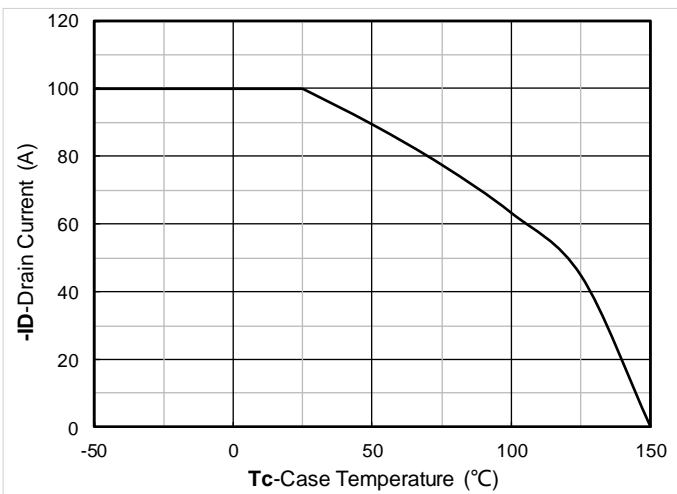


Figure 11. Current dissipation

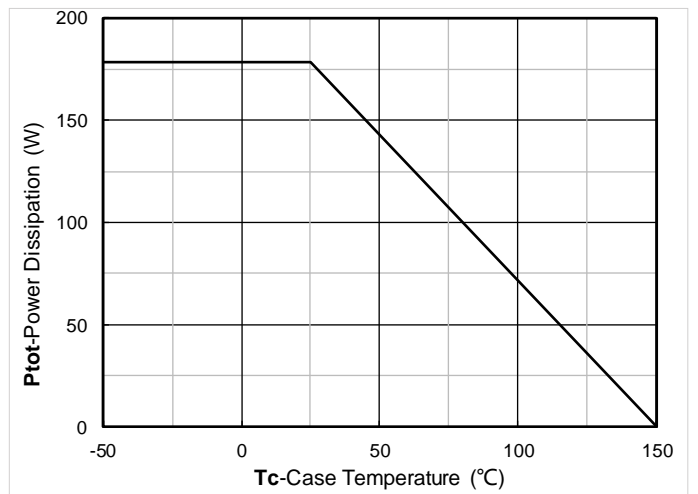


Figure 12. Power dissipation

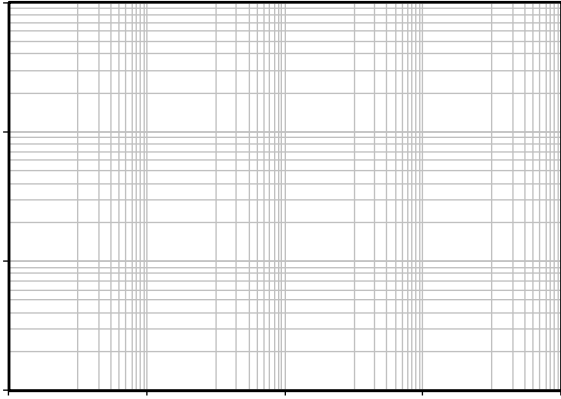


Figure 13. Maximum Transient Thermal Impedance

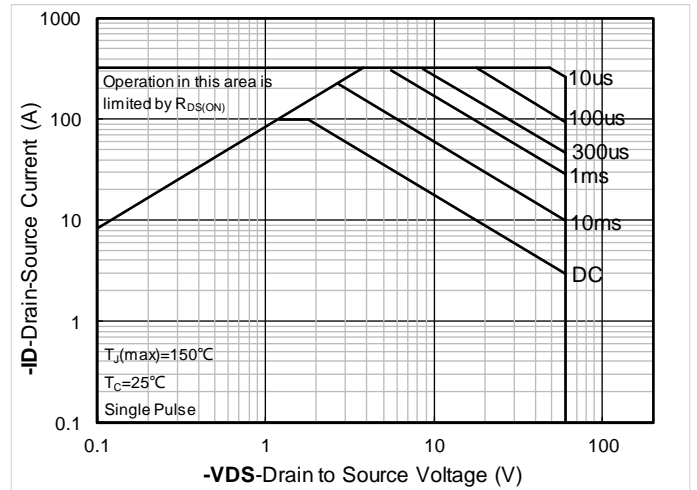
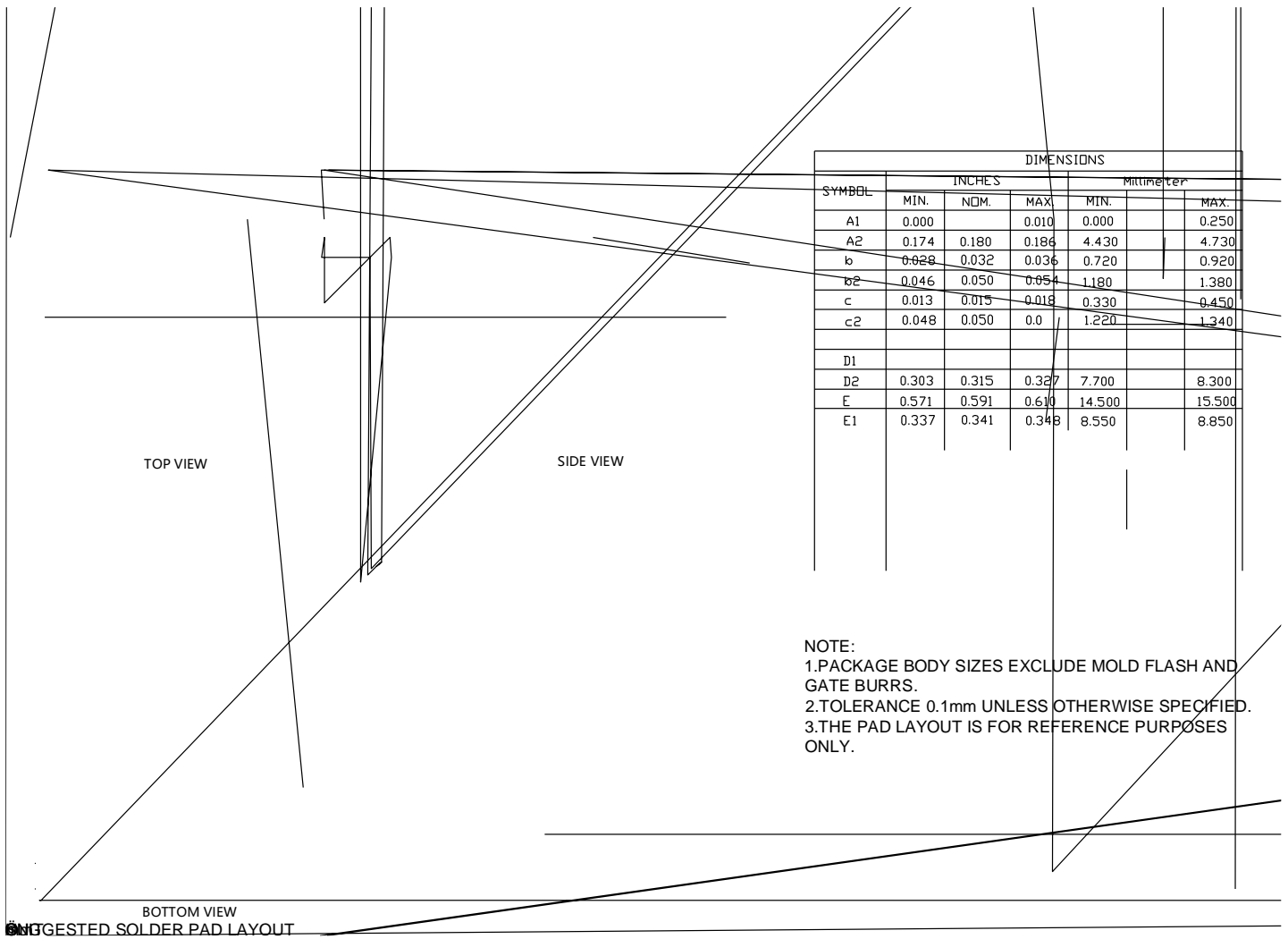


Figure 14. Safe Operation Area



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TO-263-HY Package information





YJB100GP06H

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